

Appl. No. 10/712,239
Docket No. 9103M
Amdt. dated July 3, 2007
Reply to Office Action mailed on October 17, 2006
Customer No. 27752

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AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions, and listings, of claims in the application:

Listing of Claims:

1. (Previously presented) A nonwoven substrate comprising at least one first region and at least one second region, wherein the second region comprises a strained region forming a protruding element locked by a reinforcing means in the second region selected from the group consisting of thermal bonding, chemical bonding, ionic bonding, adhesive bonding and combinations thereof.
2. (Previously presented) The nonwoven substrate of Claim 1 wherein the nonwoven substrate comprises at least about 20% thermoplastic material and the protruding elements of the second region are locked by means of thermal bonding.
3. (Original) The nonwoven substrate of Claim 2 wherein the second region contains furrows and ridges.
4. (Original) The nonwoven substrate of Claim 3 wherein the second region provides abrasivity when the nonwoven substrate is utilized in cleaning.
5. (Original) A wet wipe comprising the nonwoven substrate of Claim 1.
6. (Original) A wet wipe of Claim 5 wherein a liquid is applied to the nonwoven substrate before use.
7. (Original) A pre-moistened wet wipe of Claim 5 wherein a liquid is applied to the nonwoven substrate prior to packaging.

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8. (Original) The wet wipe of Claim 5 wherein the nonwoven substrate is a laminate of webs comprising of at least one fibrous web.
9. (Original) The wet wipe of Claim 7 wherein the amount of liquid added is in the range of from about 10% to about 500% by weight of the dry nonwoven substrate.
10. (Currently amended) A wet wipe having a basis weight and a thickness, comprising:
a nonwoven substrate which is subject to a texturing process which does not increase the basis weight, the nonwoven substrate comprising at least one first region and at least one second region, wherein the second region comprises a strained region forming a protruding element locked by a reinforcing means in the second region, and
a liquid,
wherein the thickness of said wet wipe is at least about 30% greater than the thickness of the wet nonwoven substrate prior to being textured.
11. (Original) The wet wipe of Claim 10 wherein the thickness of said wet wipe after being subject to external forces is at least about 30% greater than the thickness of the wet non-textured nonwoven substrate after being subject to external forces.

Claims 12- 20 (canceled).